



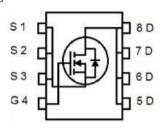
# MJ N-Channel Super Trench II Power MOSFET

#### Description

The series of devices uses Super Trench II technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### General Features

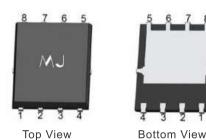
- $ightharpoonup V_{DS}=30V,I_{D}=100A$   $R_{DS(ON)}=1.75m\Omega$  (typical) @ V<sub>GS</sub>=10V  $R_{DS(ON)}=3.0m\Omega$  (typical) @ V<sub>GS</sub>=4.5V
- ◆ Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- ◆ Very low on-resistance R<sub>DS(on)</sub>
- ◆ 150°C operating temperature
- ◆ Pb-free lead plating



Schematic Diagram

#### Application

- ◆ DC/DC Converter
- ♦ Ideal for high-frequency switching and synchronous rectification



DFN 5X6

#### 100% UIS TESTED! 100% ΔVds TESTED!

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
P020N30GU	MJXP020N30GU	DFN5X6-8L	4	-	2

#### Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lo	100	А
Drain Current-Continuous(Tc =100°C)	<b>I</b> D(100℃)	78	А
Pulsed Drain Current	Ірм	400	А
Maximum Power Dissipation	Po	70	W
Derating factor		0.56	W/°C
Single pulse avalanche energy (Note 5)	Eas	352	mJ
Operating Junction and Storage Temperature Range	Тл,Тѕтс	-55 To 150	°C

#### Thermal Characteristic

Thermal Resistance,Junction-to-Case (Note 2) Rejc 1.8 °C/W
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## Electrical Characteristics (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BVDSS	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	-	-	V
Zero Gate Voltage Drain Current	loss	Vps=30V,Vgs=0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V <sub>DS</sub> =±20V,V <sub>DS</sub> =0V	_	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	VGS(th)	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	1.0	1.6	2.0	V
Desir Ossess On Otata Basistana	December	V <sub>GS</sub> =10V,I <sub>D</sub> =50A	-	1.75	2.0	mΩ
Drain-Source On-State Resistance	Rds(on)	V <sub>GS</sub> =4.5V,I <sub>D</sub> =50A	-	3.0	4.0	mΩ
Forward Transconductance	grs	V <sub>DS</sub> =5V,I <sub>D</sub> =50A	-	65	-	S
Dynamic Characteristics (Note 4)			1			
Input Capacitance	Clss	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V F=1.0MHz	_	2400	-	PF
Output Capacitance	Coss		-	1700	-	PF
Reverse Transfer Capacitance	Crss		-	120	-	PF
Switching Characteristics (Note 4)			1			
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =15V,I <sub>D</sub> =50A V <sub>GS</sub> =10V,R <sub>G</sub> =1.6Ω	-	5.0	-	nS
Turn-on Rise Time	tr		_	7.0	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>		_	27.0	-	nS
Turn-Off Fall Time	tr		-	5.0	-	nS
Total Gate Charge	Qg		-	40.5	-	nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =15V,I <sub>D</sub> =50A V <sub>GS</sub> =10V	_	6.5	-	nC
Gate-Drain Charge	Qgd		_	7.0	_	nC
Drain-Source Diode Characteristics				<u> </u>		<u> </u>
Diode Forward Voltage (Note 3)	Vsp	V <sub>GS</sub> =0V,I <sub>S</sub> =50A	_	_	1.2	V
Diode Forward Current (Note 2)	Is		_	_	100	A
Reverse Recovery Time	trr		_	14	_	nS
Reverse Recovery Charge	Qrr	TJ=25°C,IF= Is di/dt= 100A/µs (Note 3)	_	21	_	nC
Trevelse recovery Charge	Qrr				_	110

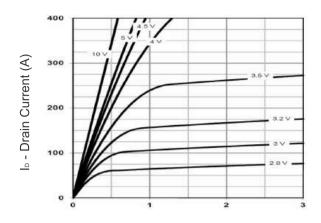
#### Notes:

- 1) Repetitive Rating: Pulse width limited by maximum junction temperature.
- Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- (4) Guaranteed by design, not subject to production
- $\ensuremath{\texttt{(5)}}$  EAS condition : Tj=25°C,VDD=20V,VG=10V,L=0.5mH,Rg=25 $\Omega$

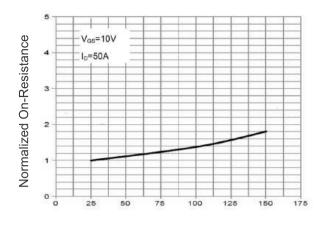




### Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)
Figure 1 Output Characteristics



T<sub>J</sub>-Junction Temperature (°C)
Figure 4 Rdson-Junction Temperature

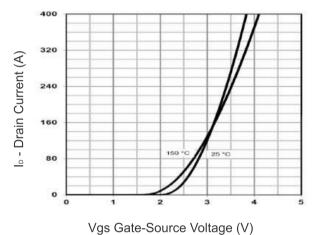
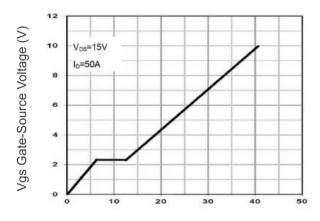


Figure 2 Transfer Characteristics



Qg Gate Charge (nC)
Figure 5 Gate Charge

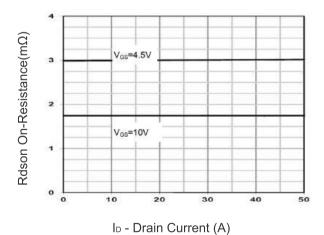
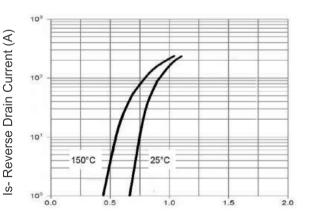
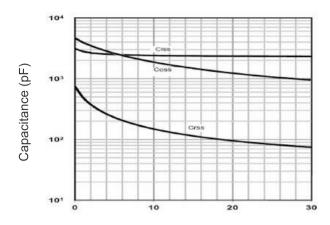


Figure 3 Rdson- Drain Current

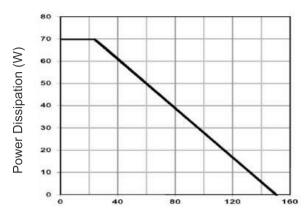


Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward

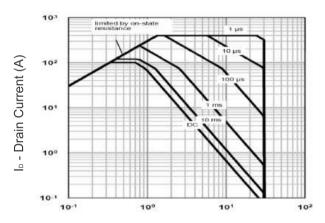




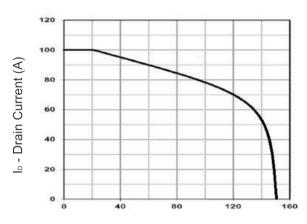
Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



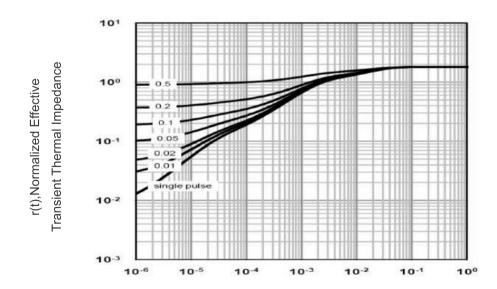
T<sub>J</sub>-Junction Temperature (°C) Figure 9 Power De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area



T<sub>J</sub>-Junction Temperature (°C)
Figure 10 Current De-rating



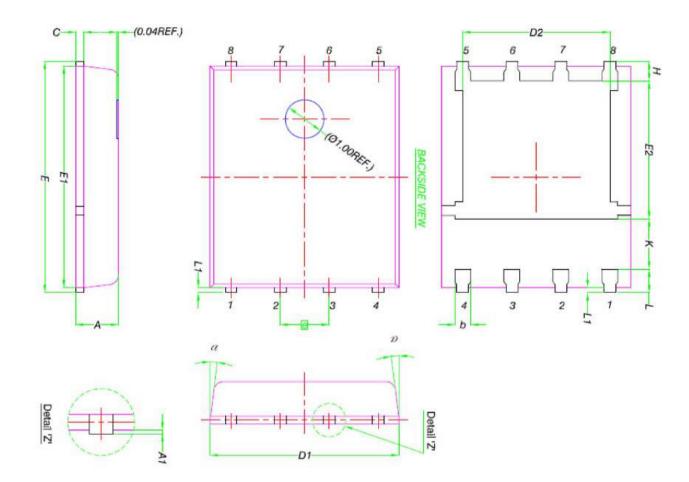
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance

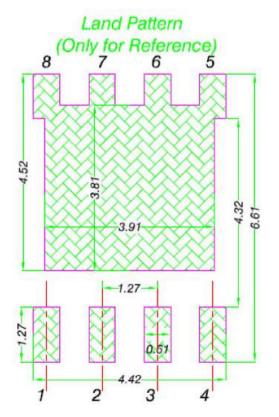




# DFN5X6-8L Package Information



044	MILLIMETERS			
DIM.	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0	•	0.05	
b	0.33	0.41	0.51	
С	0.20	0.25	0.30	
D1	4.80	4.90	5.00	
D2	3.61	3.81	3.96	
Ε	5.90	6.00	6.10	
E1	5.70	5.75	5.80	
E2	3.38	3.58	3.78	
е	1.27 BSC			
Н	0.41	0.51	0.61	
K	1.10	#×2	300	
L	0.51	0.61	0.71	
L1	0.06	0.13	0.20	
α	O°	-	12°	





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